504156807 12/28/2016

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT4203481

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LEI ZHANG	12/16/2016
FANG OU	12/16/2016
QIMING LI	12/16/2016

RECEIVING PARTY DATA

Name:	HONG KONG BEIDA JADE BIRD DISPLAY LIMITED	
Street Address:	UNIT 7605, 76/F THE CENTER, QUEEN'S RD CENTRAL	
City:	HONG KONG	
State/Country:	HONG KONG	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15269954

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	: 33008/US	
NAME OF SUBMITTER:	MICHAEL W. FARN, REG. 41,015	
SIGNATURE: /Michael W. Farn/		
DATE SIGNED:	12/28/2016	

Total Attachments: 2

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PATENT 504156807 REEL: 040788 FRAME: 0514

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to Hong Kong Beida Jade Bird Display Limited, a limited liability company of Hong Kong, having a place of business at Unit 7605, 76/F The Center, Queen's Rd Central, Hong Kong, P.R. China ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

- 1. The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the following provisional or non-provisional application filed under 35 U.S.C. § 111, design application filed under 35 U.S.C. § 171, international application filed according to the Patent Cooperation Treaty (PCT), or U.S. national phase application filed under 35 U.S.C. § 371 ("APPLICATION"):
 - Application No. 15/269,954, entitled "Making Semiconductor Devices with Alignment Bonding and Substrate Removal," filed on September 19, 2016, which claims priority from a provisional application, filed on December 21, 2015, now bearing U.S. Application No. 62/270,376.
- 2. The entire worldwide right, title, and interest in and to:
 (a) the APPLICATION; (b) all applications claiming priority from the APPLICATION;
 (c) all provisional, utility, divisional, continuation, substitute, renewal, reissue, and other applications related thereto that have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) that may be granted on the applications set forth in (a), (b), and (c) above; and (e) all right of priority in the APPLICATION and in any underlying provisional or foreign application, together with all rights to recover damages for infringement of provisional rights.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant; mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

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32810/33008/DOCS/3971691.1

Title:	Making Semiconductor Devices with Alignme		Removal
Filed:	September 19, 2016	Attorney Docket #:	32810-33008/US
Application #:	15/269,954		

INVENTOR grants the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

Name and Signature	Date of Signature
They Li	12/16/2016
Lei Zhang	
Name and Signature	Date of Signature
Forg Ou	12/16/2016
Fang Ou	
Name and Signature	Date of Signature
The filly	2016-12-16

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Qiming Li